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Kind regards,

Team Nexperia

# 74LVC1G17

## Single Schmitt trigger buffer

Rev. 11 — 2 December 2016

Product data sheet

### 1. General description

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The 74LVC1G17 provides a buffer function with Schmitt trigger input. It is capable of transforming slowly changing input signals into sharply defined outputs.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features and benefits

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- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- $\pm 24$  mA output drive ( $V_{CC} = 3.0$  V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from  $-40$  °C to  $+85$  °C and from  $-40$  °C to  $+125$  °C



### 3. Ordering information

Table 1. Ordering information

| Type number | Package           |        |                                                                                                                        |          |
|-------------|-------------------|--------|------------------------------------------------------------------------------------------------------------------------|----------|
|             | Temperature range | Name   | Description                                                                                                            | Version  |
| 74LVC1G17GW | −40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm                                                 | SOT353-1 |
| 74LVC1G17GV | −40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads                                                                               | SOT753   |
| 74LVC1G17GM | −40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm                            | SOT886   |
| 74LVC1G17GF | −40 °C to +125 °C | XSON6  | plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm                               | SOT891   |
| 74LVC1G17GN | −40 °C to +125 °C | XSON6  | extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm                                  | SOT1115  |
| 74LVC1G17GS | −40 °C to +125 °C | XSON6  | extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm                                  | SOT1202  |
| 74LVC1G17GX | −40 °C to +125 °C | X2SON5 | X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.35 mm | SOT1226  |

### 4. Marking

Table 2. Marking codes

| Type number | Marking <sup>[1]</sup> |
|-------------|------------------------|
| 74LVC1G17GW | VJ                     |
| 74LVC1G17GV | V17                    |
| 74LVC1G17GM | VJ                     |
| 74LVC1G17GF | VJ                     |
| 74LVC1G17GN | VJ                     |
| 74LVC1G17GS | VJ                     |
| 74LVC1G17GX | VJ                     |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 5. Functional diagram

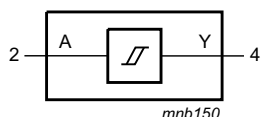


Fig 1. Logic symbol

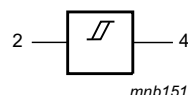


Fig 2. IEC logic symbol

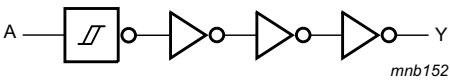


Fig 3. Logic diagram

6. Pinning information

6.1 Pinning

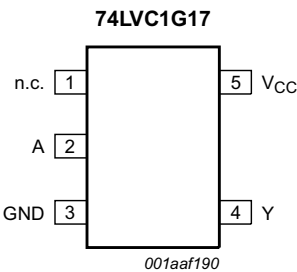


Fig 4. Pin configuration SOT353-1 and SOT753

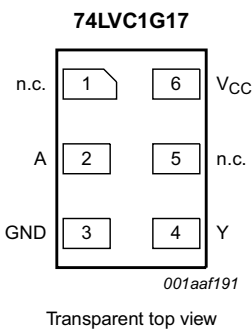


Fig 5. Pin configuration SOT886

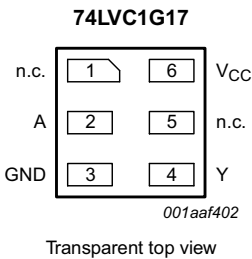


Fig 6. Pin configuration SOT891, SOT1115 and SOT1202

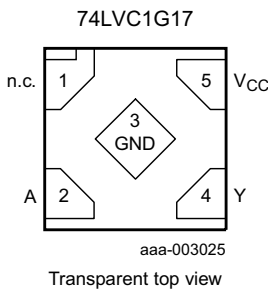


Fig 7. Pin configuration SOT1226 (X2SON5)

6.2 Pin description

Table 3. Pin description

| Symbol          | Pin               |       | Description    |
|-----------------|-------------------|-------|----------------|
|                 | TSSOP5 and X2SON5 | XSON6 |                |
| n.c.            | 1                 | 1, 5  | not connected  |
| A               | 2                 | 2     | data input     |
| GND             | 3                 | 3     | ground (0 V)   |
| Y               | 4                 | 4     | data output    |
| V <sub>CC</sub> | 5                 | 6     | supply voltage |

## 7. Functional description

Table 4. Function table<sup>[1]</sup>

| Input | Output |
|-------|--------|
| A     | Y      |
| L     | L      |
| H     | H      |

[1] H = HIGH voltage level; L = LOW voltage level

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                                   | Min  | Max            | Unit |
|-----------|-------------------------|----------------------------------------------|------|----------------|------|
| $V_{CC}$  | supply voltage          |                                              | -0.5 | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                                  | -50  | -              | mA   |
| $V_I$     | input voltage           | <sup>[1]</sup>                               | -0.5 | +6.5           | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V                | -    | ±50            | mA   |
| $V_O$     | output voltage          | Active mode <sup>[1][2]</sup>                | -0.5 | $V_{CC} + 0.5$ | V    |
|           |                         | Power-down mode <sup>[1][2]</sup>            | -0.5 | +6.5           | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$                      | -    | ±50            | mA   |
| $I_{CC}$  | supply current          |                                              | -    | 100            | mA   |
| $I_{GND}$ | ground current          |                                              | -100 | -              | mA   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C <sup>[3]</sup> | -    | 250            | mW   |
| $T_{stg}$ | storage temperature     |                                              | -65  | +150           | °C   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When  $V_{CC} = 0$  V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.  
For XSON6 and X2SON5 package: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol    | Parameter           | Conditions                      | Min  | Typ | Max      | Unit |
|-----------|---------------------|---------------------------------|------|-----|----------|------|
| $V_{CC}$  | supply voltage      |                                 | 1.65 | -   | 5.5      | V    |
| $V_I$     | input voltage       |                                 | 0    | -   | 5.5      | V    |
| $V_O$     | output voltage      | Active mode                     | 0    | -   | $V_{CC}$ | V    |
|           |                     | $V_{CC} = 0$ V; Power-down mode | 0    | -   | 5.5      | V    |
| $T_{amb}$ | ambient temperature |                                 | -40  | -   | +125     | °C   |

## 10. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                                     | Parameter                 | Conditions                                                                                                   | Min                   | Typ <sup>[1]</sup> | Max  | Unit |
|--------------------------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------|-----------------------|--------------------|------|------|
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b>  |                           |                                                                                                              |                       |                    |      |      |
| V <sub>OH</sub>                            | HIGH-level output voltage | V <sub>I</sub> = V <sub>T+</sub> or V <sub>T-</sub>                                                          |                       |                    |      |      |
|                                            |                           | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                  | V <sub>CC</sub> - 0.1 | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V                                                             | 1.2                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V                                                              | 1.9                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V                                                             | 2.2                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V                                                             | 2.3                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V                                                             | 3.8                   | -                  | -    | V    |
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>T+</sub> or V <sub>T-</sub>                                                          |                       |                    |      |      |
|                                            |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                   | -                     | -                  | 0.1  | V    |
|                                            |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                              | -                     | -                  | 0.45 | V    |
|                                            |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                               | -                     | -                  | 0.3  | V    |
|                                            |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                              | -                     | -                  | 0.4  | V    |
|                                            |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                              | -                     | -                  | 0.55 | V    |
|                                            |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V                                                              | -                     | -                  | 0.55 | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V                                                | -                     | ±0.1               | ±1   | µA   |
| I <sub>OFF</sub>                           | power-off leakage current | V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0 V                                              | -                     | ±0.1               | ±2   | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = 5.5 V or GND;<br>V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A                    | -                     | 0.1                | 4    | µA   |
| ΔI <sub>CC</sub>                           | additional supply current | V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 2.3 V to 5.5 V; per pin | -                     | 5                  | 500  | µA   |
| C <sub>I</sub>                             | input capacitance         |                                                                                                              | -                     | 5                  | -    | pF   |
| <b>T<sub>amb</sub> = -40 °C to +125 °C</b> |                           |                                                                                                              |                       |                    |      |      |
| V <sub>OH</sub>                            | HIGH-level output voltage | V <sub>I</sub> = V <sub>T+</sub> or V <sub>T-</sub>                                                          |                       |                    |      |      |
|                                            |                           | I <sub>O</sub> = -100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                  | V <sub>CC</sub> - 0.1 | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V                                                             | 0.95                  | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V                                                              | 1.7                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V                                                             | 1.9                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V                                                             | 2.0                   | -                  | -    | V    |
|                                            |                           | I <sub>O</sub> = -32 mA; V <sub>CC</sub> = 4.5 V                                                             | 3.4                   | -                  | -    | V    |
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>T+</sub> or V <sub>T-</sub>                                                          |                       |                    |      |      |
|                                            |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 5.5 V                                                   | -                     | -                  | 0.1  | V    |
|                                            |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                              | -                     | -                  | 0.7  | V    |
|                                            |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                               | -                     | -                  | 0.45 | V    |
|                                            |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                              | -                     | -                  | 0.6  | V    |
|                                            |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                              | -                     | -                  | 0.80 | V    |
|                                            |                           | I <sub>O</sub> = 32 mA; V <sub>CC</sub> = 4.5 V                                                              | -                     | -                  | 0.80 | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V                                                | -                     | -                  | ±1   | µA   |

**Table 7.** Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions                                                                 | Min | Typ <sup>[1]</sup> | Max     | Unit    |
|-----------------|---------------------------|----------------------------------------------------------------------------|-----|--------------------|---------|---------|
| $I_{OFF}$       | power-off leakage current | $V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V                                     | -   | -                  | $\pm 2$ | $\mu$ A |
| $I_{CC}$        | supply current            | $V_I = 5.5$ V or GND;<br>$V_{CC} = 1.65$ V to 5.5 V; $I_O = 0$ A           | -   | -                  | 4       | $\mu$ A |
| $\Delta I_{CC}$ | additional supply current | per pin; $V_I = V_{CC} - 0.6$ V; $I_O = 0$ A;<br>$V_{CC} = 2.3$ V to 5.5 V | -   | -                  | 500     | $\mu$ A |

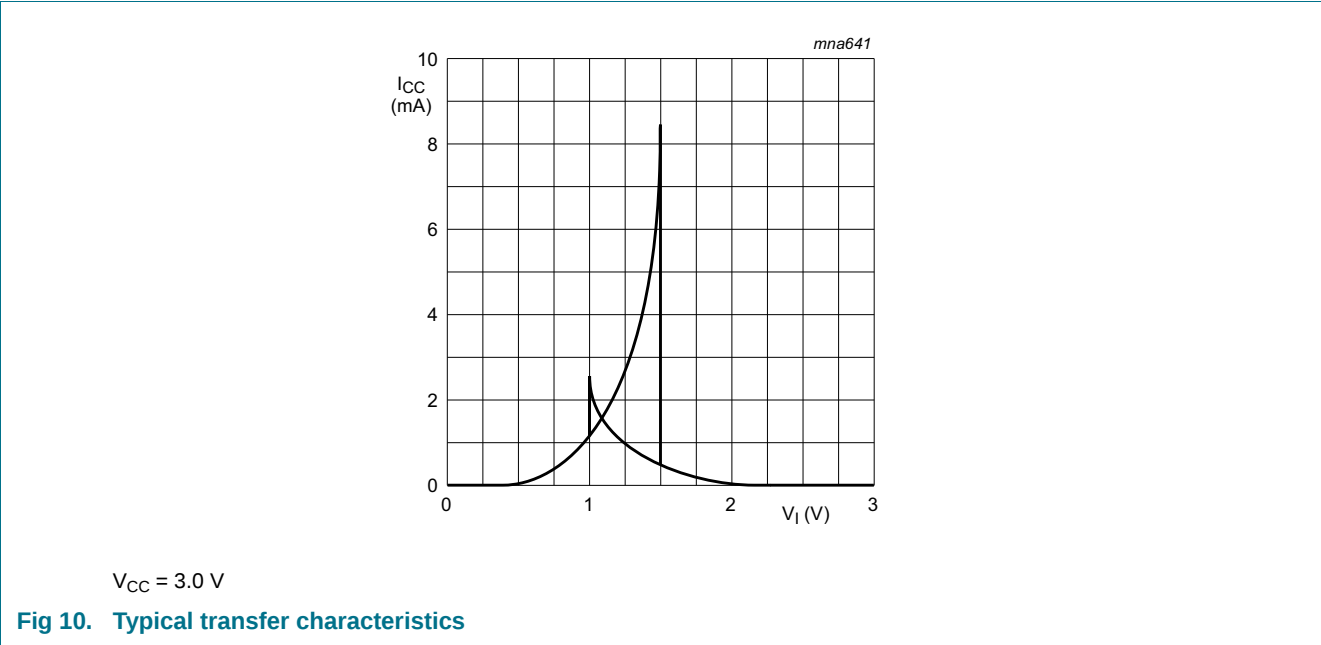
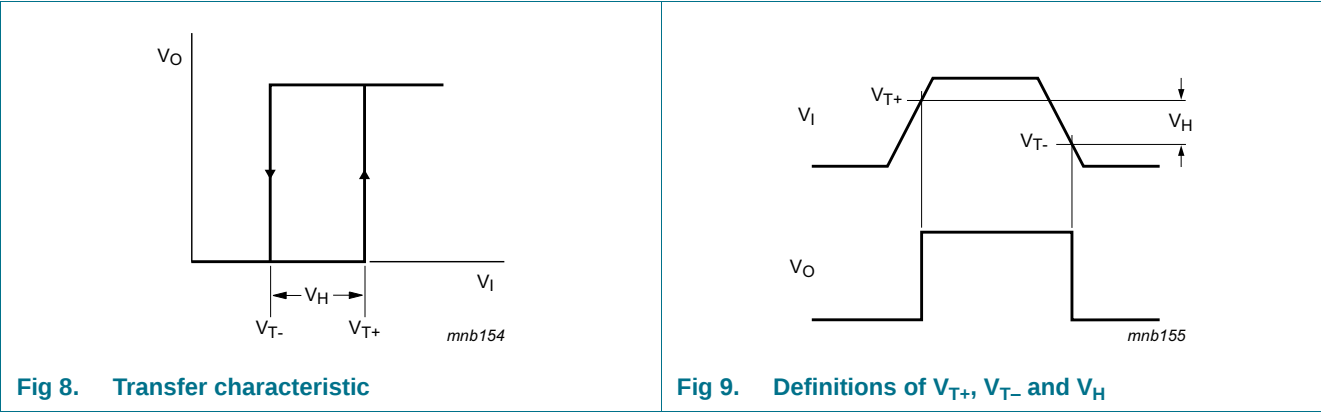
[1] All typical values are measured at maximum  $V_{CC}$  and  $T_{amb} = 25$  °C.**Table 8.** Transfer characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol   | Parameter                        | Conditions                                                                            | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|----------|----------------------------------|---------------------------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|          |                                  |                                                                                       | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| $V_{T+}$ | positive-going threshold voltage | see <a href="#">Figure 8</a> and <a href="#">Figure 9</a>                             |                  |                    |      |                   |      |      |
|          |                                  | $V_{CC} = 1.8$ V                                                                      | 0.82             | 1.0                | 1.14 | 0.79              | 1.14 | V    |
|          |                                  | $V_{CC} = 2.3$ V                                                                      | 1.03             | 1.2                | 1.40 | 1.00              | 1.40 | V    |
|          |                                  | $V_{CC} = 3.0$ V                                                                      | 1.29             | 1.5                | 1.71 | 1.26              | 1.71 | V    |
|          |                                  | $V_{CC} = 4.5$ V                                                                      | 1.84             | 2.1                | 2.36 | 1.81              | 2.36 | V    |
|          |                                  | $V_{CC} = 5.5$ V                                                                      | 2.19             | 2.5                | 2.79 | 2.16              | 2.79 | V    |
| $V_{T-}$ | negative-going threshold voltage | see <a href="#">Figure 8</a> and <a href="#">Figure 9</a>                             |                  |                    |      |                   |      |      |
|          |                                  | $V_{CC} = 1.8$ V                                                                      | 0.46             | 0.6                | 0.75 | 0.46              | 0.78 | V    |
|          |                                  | $V_{CC} = 2.3$ V                                                                      | 0.65             | 0.8                | 0.96 | 0.65              | 0.99 | V    |
|          |                                  | $V_{CC} = 3.0$ V                                                                      | 0.88             | 1.0                | 1.24 | 0.88              | 1.27 | V    |
|          |                                  | $V_{CC} = 4.5$ V                                                                      | 1.32             | 1.5                | 1.84 | 1.32              | 1.87 | V    |
|          |                                  | $V_{CC} = 5.5$ V                                                                      | 1.58             | 1.8                | 2.24 | 1.58              | 2.27 | V    |
| $V_H$    | hysteresis voltage               | see <a href="#">Figure 8</a> , <a href="#">Figure 9</a> and <a href="#">Figure 10</a> |                  |                    |      |                   |      |      |
|          |                                  | $V_{CC} = 1.8$ V                                                                      | 0.26             | 0.4                | 0.51 | 0.19              | 0.51 | V    |
|          |                                  | $V_{CC} = 2.3$ V                                                                      | 0.28             | 0.4                | 0.57 | 0.22              | 0.57 | V    |
|          |                                  | $V_{CC} = 3.0$ V                                                                      | 0.31             | 0.5                | 0.64 | 0.25              | 0.64 | V    |
|          |                                  | $V_{CC} = 4.5$ V                                                                      | 0.40             | 0.6                | 0.77 | 0.34              | 0.77 | V    |
|          |                                  | $V_{CC} = 5.5$ V                                                                      | 0.47             | 0.6                | 0.88 | 0.41              | 0.88 | V    |

[1] All typical values are measured at  $T_{amb} = 25$  °C.

10.1 Transfer characteristic waveforms



## 11. Dynamic characteristics

**Table 9. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 12](#).

| Symbol          | Parameter                     | Conditions                                                                          | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|-----------------|-------------------------------|-------------------------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|                 |                               |                                                                                     | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub> | propagation delay             | A to Y; see <a href="#">Figure 11</a> <sup>[2]</sup>                                |                  |                    |      |                   |      |      |
|                 |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                                  | 1.0              | 4.1                | 11.0 | 1.0               | 14.0 | ns   |
|                 |                               | V <sub>CC</sub> = 2.3 V to 2.7 V                                                    | 0.7              | 2.8                | 6.5  | 0.7               | 8.5  | ns   |
|                 |                               | V <sub>CC</sub> = 2.7 V                                                             | 0.7              | 3.2                | 6.5  | 0.7               | 8.5  | ns   |
|                 |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                                    | 0.7              | 3.0                | 5.5  | 0.7               | 7.0  | ns   |
|                 |                               | V <sub>CC</sub> = 4.5 V to 5.5 V                                                    | 0.7              | 2.2                | 5.0  | 0.7               | 6.5  | ns   |
| C <sub>PD</sub> | power dissipation capacitance | V <sub>I</sub> = GND to V <sub>CC</sub> ;<br>V <sub>CC</sub> = 3.3 V <sup>[3]</sup> | -                | 16.6               | -    | -                 | -    | pF   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[3] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

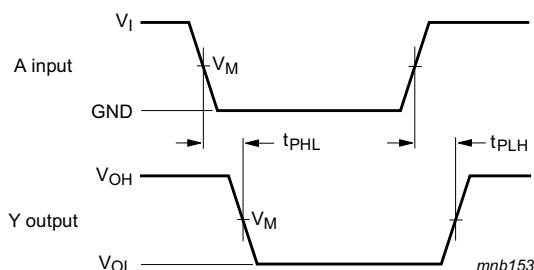
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

$\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 12. Waveforms



Measurement points are given in [Table 10](#).

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

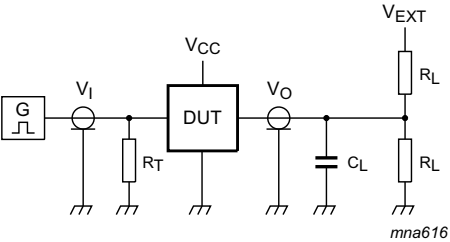
**Fig 11. The input A to output Y propagation delay times**

**Table 10. Measurement points**

| Supply voltage   | Input                 | Output                |
|------------------|-----------------------|-----------------------|
| V <sub>CC</sub>  | V <sub>M</sub>        | V <sub>M</sub>        |
| 1.65 V to 1.95 V | 0.5 × V <sub>CC</sub> | 0.5 × V <sub>CC</sub> |
| 2.3 V to 2.7 V   | 0.5 × V <sub>CC</sub> | 0.5 × V <sub>CC</sub> |

Table 10. Measurement points ...continued

| Supply voltage  | Input                 | Output                |
|-----------------|-----------------------|-----------------------|
| V <sub>CC</sub> | V <sub>M</sub>        | V <sub>M</sub>        |
| 2.7 V           | 1.5 V                 | 1.5 V                 |
| 3.0 V to 3.6 V  | 1.5 V                 | 1.5 V                 |
| 4.5 V to 5.5 V  | 0.5 × V <sub>CC</sub> | 0.5 × V <sub>CC</sub> |



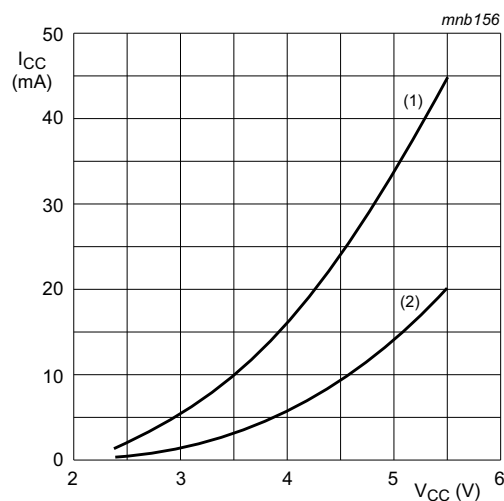
Test data is given in [Table 11](#).  
Definitions for test circuit:  
R<sub>L</sub> = Load resistance.  
C<sub>L</sub> = Load capacitance including jig and probe capacitance.  
R<sub>T</sub> = Termination resistance should be equal to the output impedance Z<sub>o</sub> of the pulse generator.  
V<sub>EXT</sub> = External voltage for measuring switching times.

Fig 12. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage   | Input           |                                 | Load           |                | V <sub>EXT</sub>                    |
|------------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|
| V <sub>CC</sub>  | V <sub>I</sub>  | t <sub>r</sub> = t <sub>f</sub> | C <sub>L</sub> | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 1.65 V to 1.95 V | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 1 kΩ           | open                                |
| 2.3 V to 2.7 V   | V <sub>CC</sub> | ≤ 2.0 ns                        | 30 pF          | 500 Ω          | open                                |
| 2.7 V            | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |
| 3.0 V to 3.6 V   | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |
| 4.5 V to 5.5 V   | V <sub>CC</sub> | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                |

## 13. Application information



Linear change of  $V_I$  between 0.8 V to 2.0 V.

- (1) Positive-going edge.
- (2) Negative-going edge.

**Fig 13. Average supply current as a function of supply voltage**

14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1

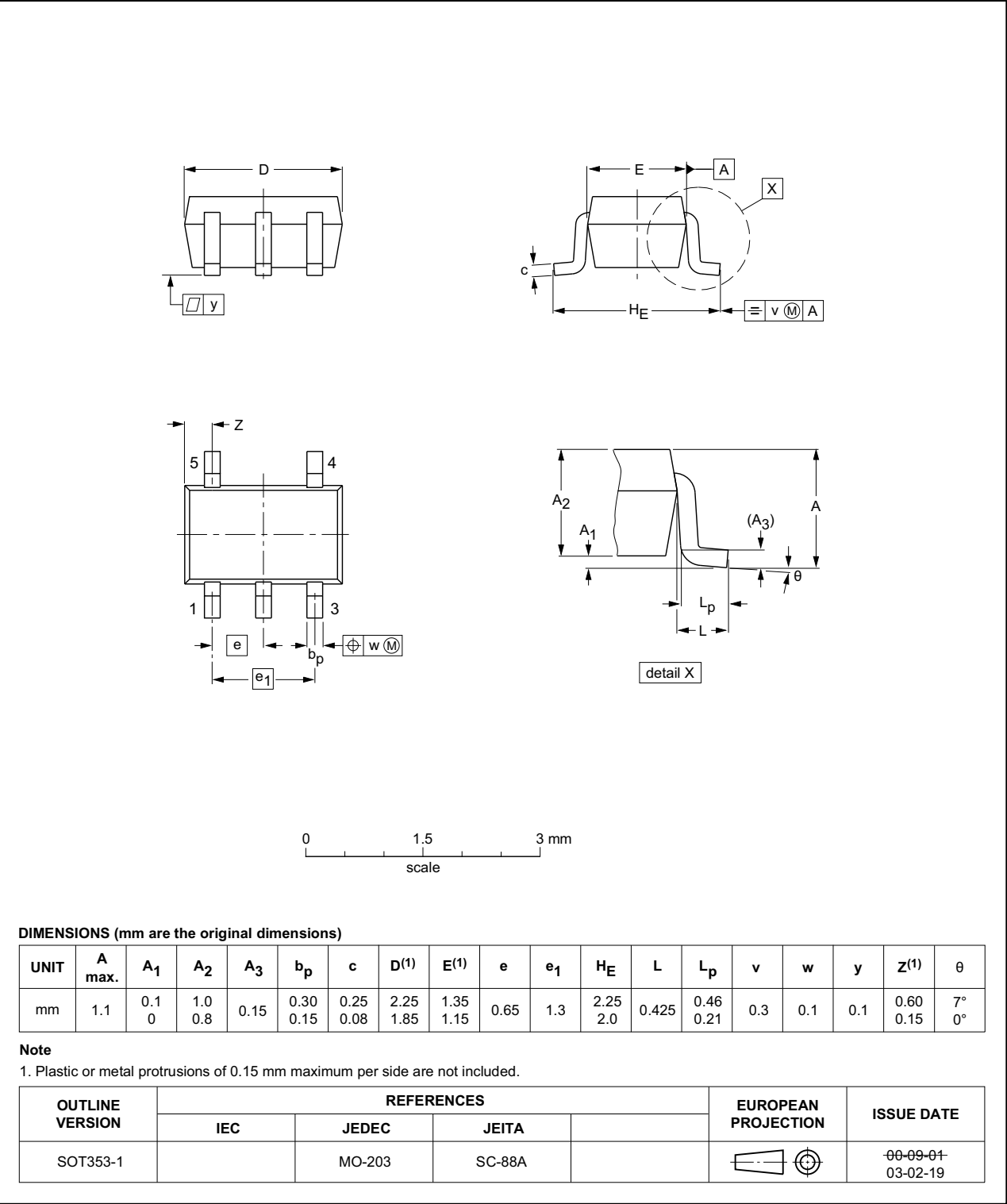
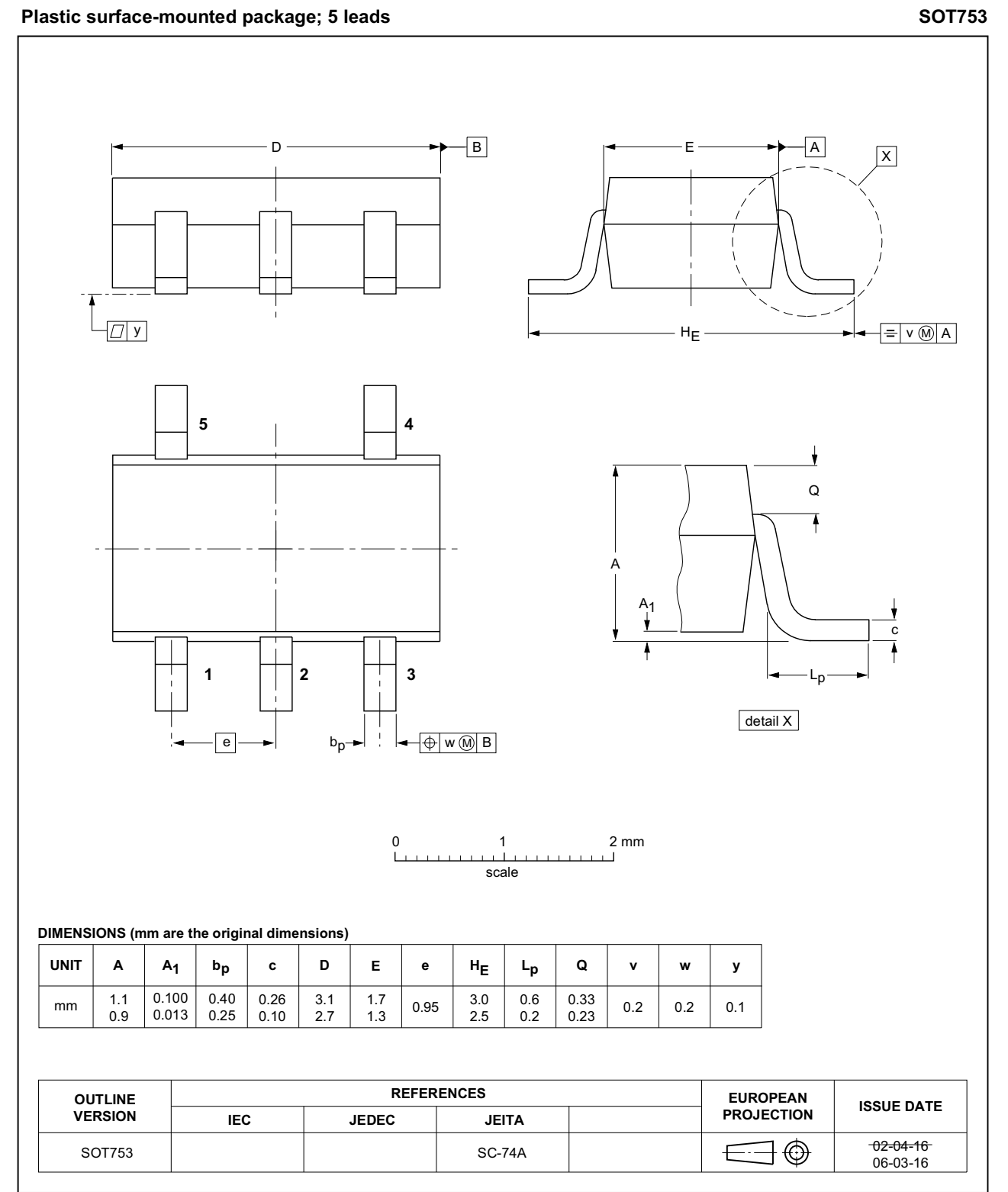


Fig 14. Package outline SOT353-1 (TSSOP5)



XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

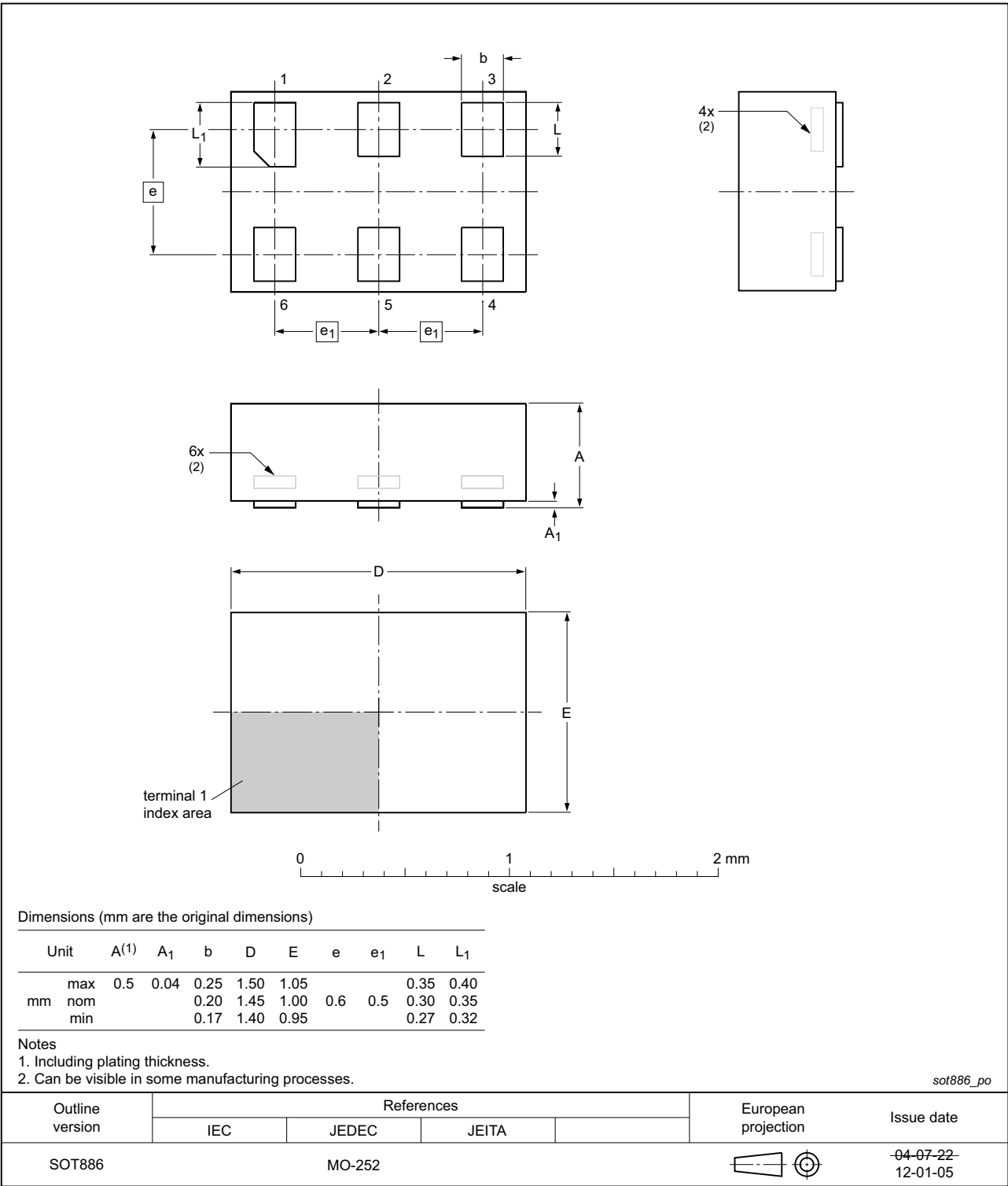


Fig 16. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

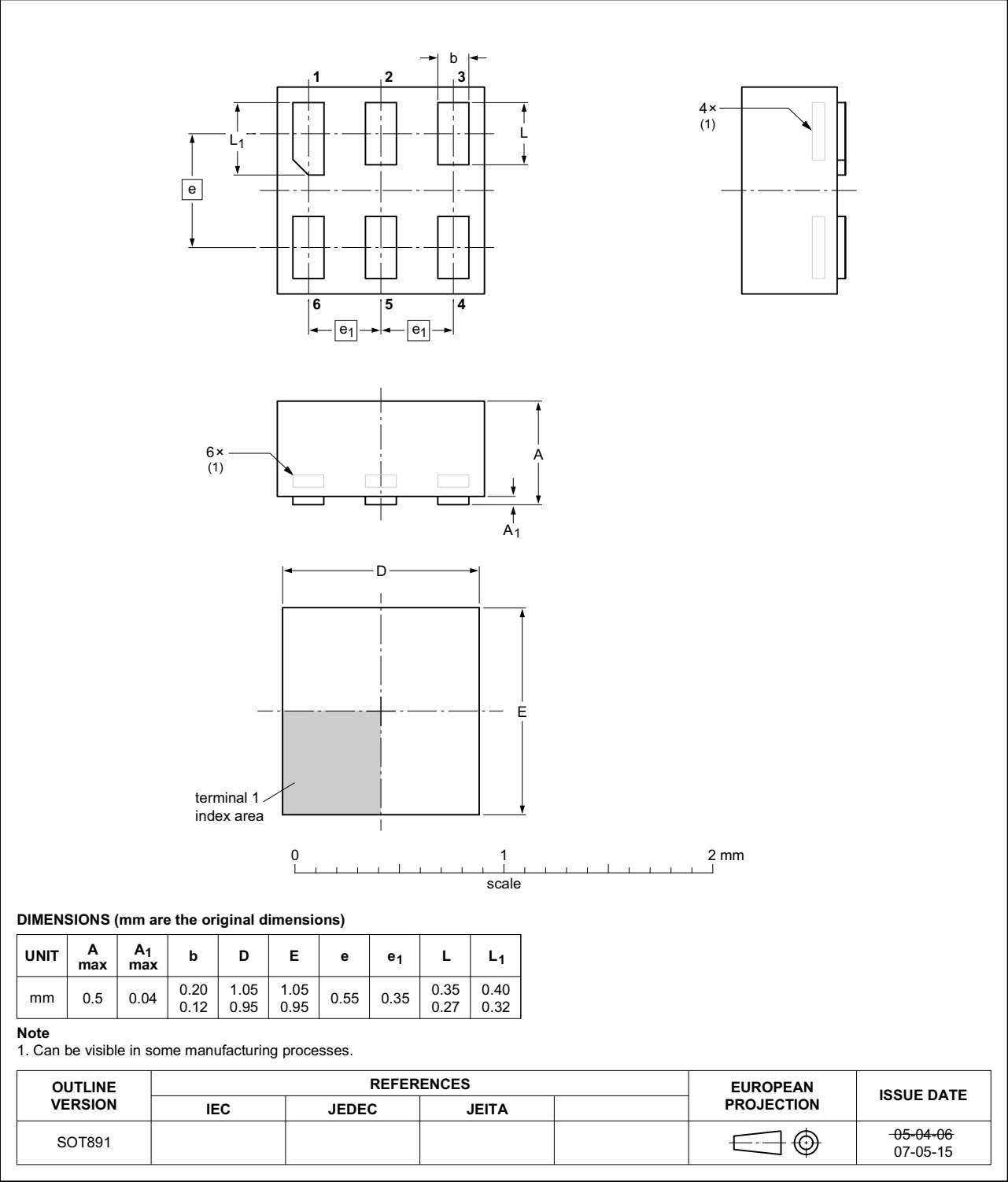
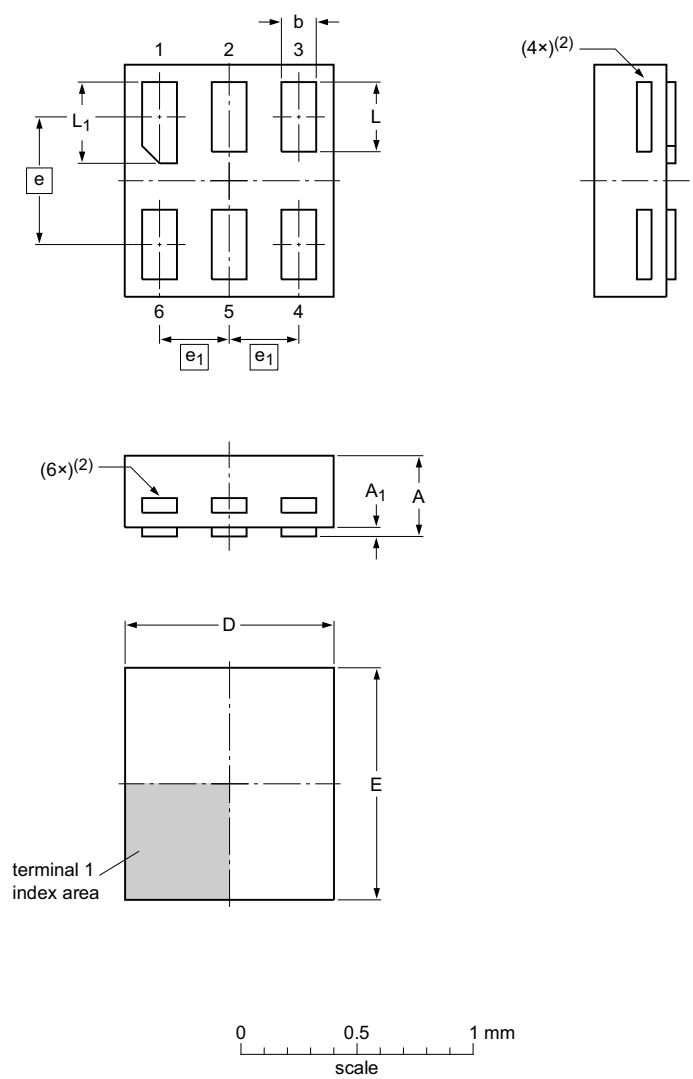


Fig 17. Package outline SOT891 (XSON6)

XSON6: extremely thin small outline package; no leads;  
6 terminals; body 0.9 x 1.0 x 0.35 mm

SOT1115



Dimensions

| Unit | A <sup>(1)</sup> | A <sub>1</sub> | b    | D    | E    | e    | e <sub>1</sub> | L    | L <sub>1</sub> |
|------|------------------|----------------|------|------|------|------|----------------|------|----------------|
| mm   | max              | 0.35           | 0.04 | 0.20 | 0.95 | 1.05 |                | 0.35 | 0.40           |
|      | nom              |                |      | 0.15 | 0.90 | 1.00 | 0.55           | 0.30 | 0.35           |
|      | min              |                |      | 0.12 | 0.85 | 0.95 |                | 0.27 | 0.32           |

Note

- 1. Including plating thickness.
- 2. Visible depending upon used manufacturing technology.

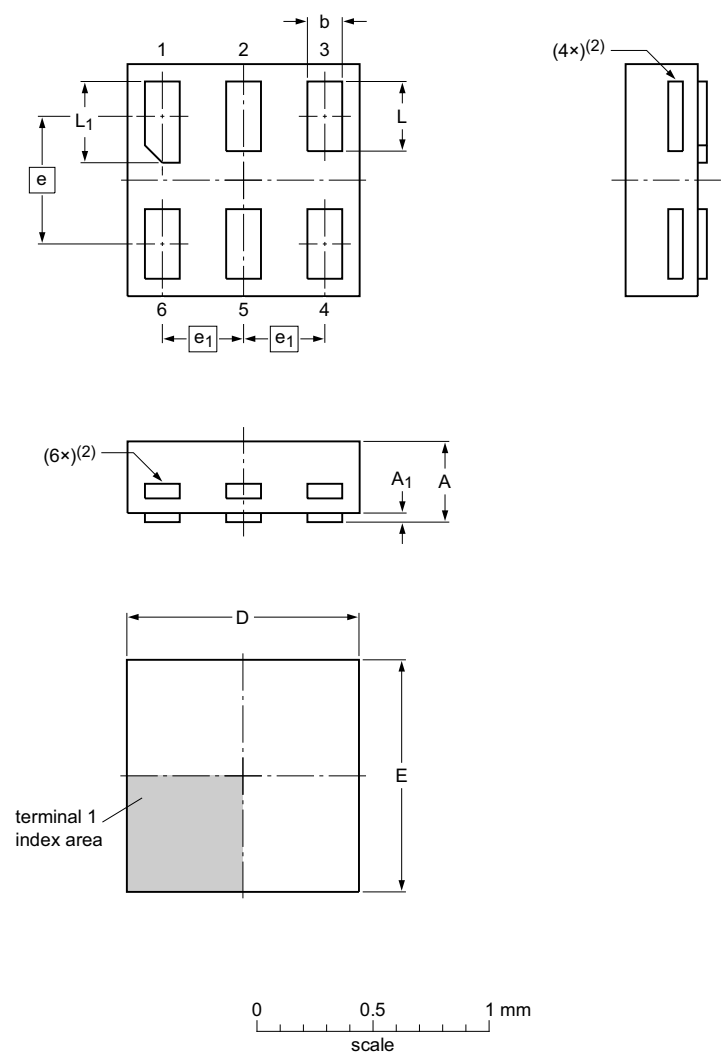
sot1115\_po

| Outline version | References |       |       |  | European projection                                                                   | Issue date                      |
|-----------------|------------|-------|-------|--|---------------------------------------------------------------------------------------|---------------------------------|
|                 | IEC        | JEDEC | JEITA |  |                                                                                       |                                 |
| SOT1115         |            |       |       |  |  | <del>10-04-02</del><br>10-04-07 |

Fig 18. Package outline SOT1115 (XSON6)

XSON6: extremely thin small outline package; no leads;  
6 terminals; body 1.0 x 1.0 x 0.35 mm

SOT1202



Dimensions

| Unit | A <sup>(1)</sup> | A <sub>1</sub> | b    | D    | E    | e    | e <sub>1</sub> | L    | L <sub>1</sub> |
|------|------------------|----------------|------|------|------|------|----------------|------|----------------|
| mm   | max              | 0.35           | 0.04 | 0.20 | 1.05 | 1.05 |                | 0.35 | 0.40           |
|      | nom              |                |      | 0.15 | 1.00 | 1.00 | 0.55           | 0.30 | 0.35           |
|      | min              |                |      | 0.12 | 0.95 | 0.95 |                | 0.27 | 0.32           |

Note

- 1. Including plating thickness.
- 2. Visible depending upon used manufacturing technology.

sot1202\_po

| Outline version | References |       |       |  | European projection                                                                   | Issue date                      |
|-----------------|------------|-------|-------|--|---------------------------------------------------------------------------------------|---------------------------------|
|                 | IEC        | JEDEC | JEITA |  |                                                                                       |                                 |
| SOT1202         |            |       |       |  |  | <del>10-04-02</del><br>10-04-06 |

Fig 19. Package outline SOT1202 (XSON6)

**X2SON5: plastic thermal enhanced extremely thin small outline package; no leads;**  
**5 terminals; body 0.8 x 0.8 x 0.35 mm**

SOT1226

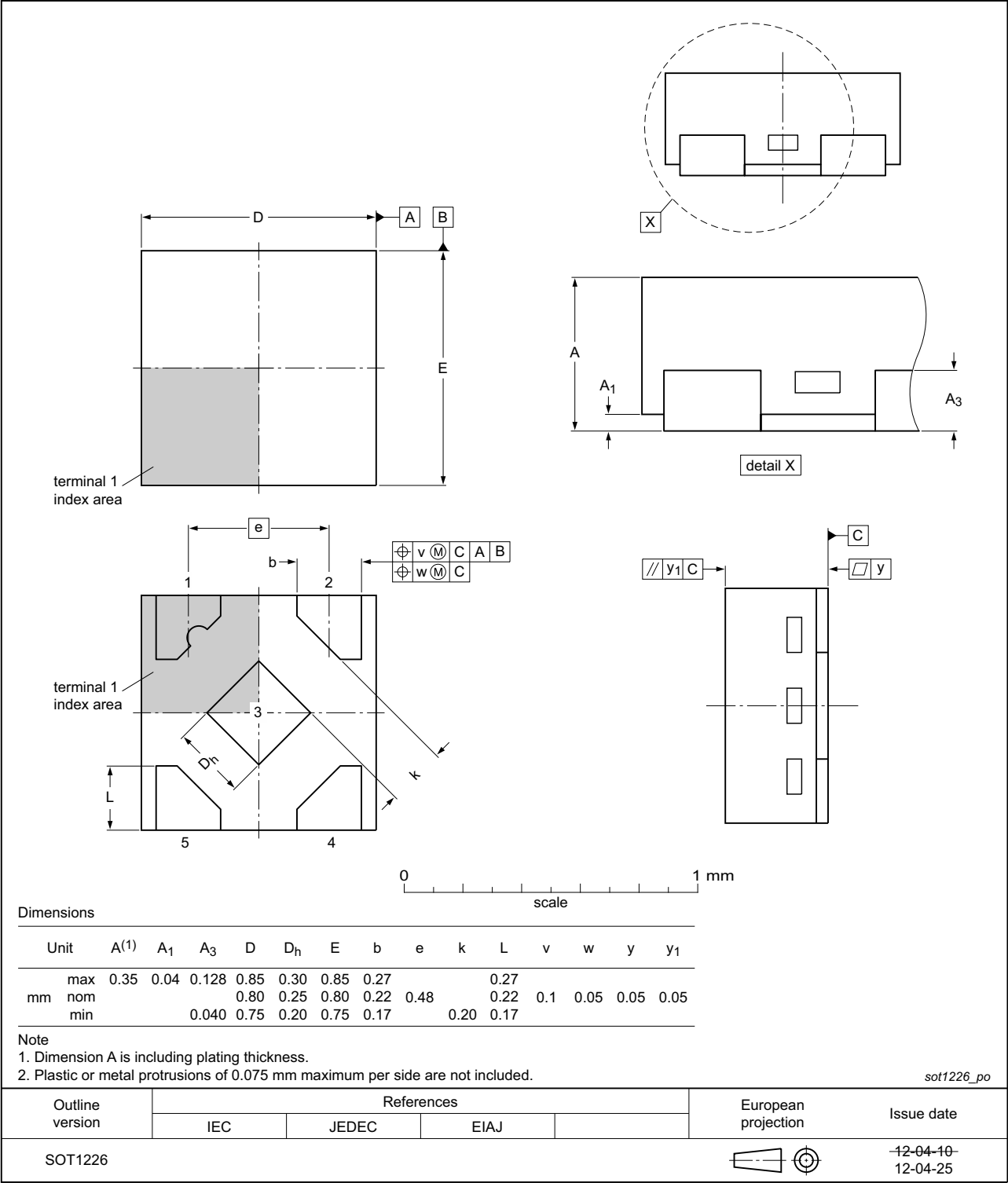


Fig 20. Package outline SOT1226 (X2SON5)

## 15. Abbreviations

Table 12. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 16. Revision history

Table 13. Revision history

| Document ID    | Release date                                                                                                                                                                   | Data sheet status     | Change notice | Supersedes     |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|----------------|
| 74LVC1G17 v.11 | 20161202                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.10 |
| Modifications: | <ul style="list-style-type: none"> <li>• <a href="#">Table 7</a>: The maximum limits for leakage current and supply current have changed.</li> </ul>                           |                       |               |                |
| 74LVC1G17 v.10 | 20120629                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.9  |
| Modifications: | <ul style="list-style-type: none"> <li>• Added type number 74LVC1G17GX (SOT1226)</li> <li>• Package outline drawing of SOT886 (<a href="#">Figure 16</a>) modified.</li> </ul> |                       |               |                |
| 74LVC1G17 v.9  | 20111206                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.8  |
| Modifications: | <ul style="list-style-type: none"> <li>• Legal pages updated.</li> </ul>                                                                                                       |                       |               |                |
| 74LVC1G17 v.8  | 20110920                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.7  |
| 74LVC1G17 v.7  | 20101110                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.6  |
| 74LVC1G17 v.6  | 20070827                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.5  |
| 74LVC1G17 v.5  | 20061006                                                                                                                                                                       | Product data sheet    | -             | 74LVC1G17 v.4  |
| 74LVC1G17 v.4  | 20041130                                                                                                                                                                       | Product specification | -             | 74LVC1G17 v.3  |
| 74LVC1G17 v.3  | 20041018                                                                                                                                                                       | Product specification | -             | 74LVC1G17 v.2  |
| 74LVC1G17 v.2  | 20040407                                                                                                                                                                       | Product specification | -             | 74LVC1G17 v.1  |
| 74LVC1G17 v.1  | 20040324                                                                                                                                                                       | Product specification | -             | -              |

## 17. Legal information

### 17.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

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[2] The term 'short data sheet' is explained in section "Definitions".

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